ART FILM - ASSY\_TOP

8	7	6	5	4	3	2	1
D							
C							
B ROWN II S							В
	MP2  MP3  MP3  MP4  MP4  MP4  MP4  MP4  MP4				APPRODRAWN: RELEASED DO NOT	ASSEMBLY DRAW  OVALS DATE SIZE KSID NO.	ENGINEER  XXXXX  XXXXXXXX  ING (TOP SIDE)  JOB NO.  XXXXXXX  REV.  1.0

ART FILM - ASSY\_BOT

8	7	6	5	4	3	2	1
D							
B							В
A	7	6	5		APPRODRAWN: RELEASED DO NOT	ASSEMBLY DRAW	ENGINEER XXXXX  XXXXXXXXXXX  ING (BOTTOM SIDE)  JOB NO.  XXXXXXX  1.0  SHEET 2 OF 2  1

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